

Rochester Electronics Manufactured Components

Rochester branded components are manufactured using either die/wafers purchased from the original suppliers or Rochester wafers recreated from the original IP. All recreations are done with the approval of the OCM.

Parts are tested using original factory test programs or Rochester developed test solutions to guarantee product meets or exceeds the OCM data sheet.

Quality Overview

- ISO-9001
- AS9120 certification
- Qualified Manufacturers List (QML) MIL-PRF-35835
 - Class Q Military
 - Class V Space Level
- Qualified Suppliers List of Distributors (QSLD)
 - Rochester is a critical supplier to DLA and meets all industry and DLA standards.

Rochester Electronics, LLC is committed to supplying products that satisfy customer expectations for quality and are equal to those originally supplied by industry manufacturers.

The original manufacturer's datasheet accompanying this document reflects the performance and specifications of the Rochester manufactured version of this device. Rochester Electronics guarantees the performance of its semiconductor products to the original OEM specifications. 'Typical' values are for reference purposes only. Certain minimum or maximum ratings may be based on product characterization, design, simulation, or sample testing.

74F381

4-Bit Arithmetic Logic Unit

General Description

The 74F381 performs three arithmetic and three logic operations on two 4-bit words, A and B. Two additional select input codes force the function outputs LOW or HIGH. Carry propagate and generate outputs are provided for use with the 74F182 carry lookahead generator for high-speed expansion to longer word lengths. For ripple expansion, refer to the 74F382 ALU data sheet.

Features

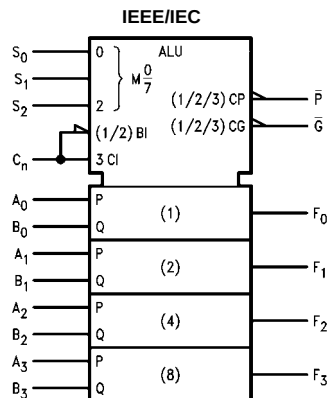
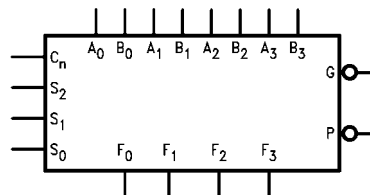
- Low input loading minimizes drive requirements
- Performs six arithmetic and logic functions
- Selectable LOW (clear) and HIGH (preset) functions
- Carry generate and propagate outputs for use with carry lookahead generator

Ordering Code:

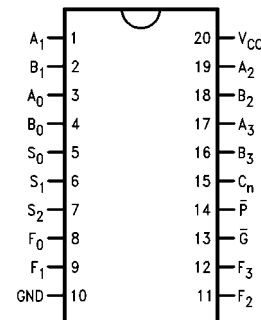
Order Number	Package Number	Package Description
74F381SC	M20B	20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
74F381SJ	M20D	20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
74F381PC	N20A	20-Lead Plastic Dual-In-Line Package (PDIP), JEDEC MS-001, 0.300 Wide

Devices also available in Tape and Reel. Specify by appending the suffix letter "X" to the ordering code.

Logic Symbols



Connection Diagram



Unit Loading/Fan Out

Pin Names	Description	U.L. HIGH/LOW	Input I_{IH}/I_{IL} Output I_{OH}/I_{OL}
A_0-A_3	A Operand Inputs	1.0/3.0	20 μA /-1.8 mA
B_0-B_3	B Operand Inputs	1.0/3.0	20 μA /-1.8 mA
S_0-S_2	Function Select Inputs	1.0/1.0	20 μA /-0.6 mA
C_n	Carry Input	1.0/4.0	20 μA /-2.4 mA
$\bar{G}$	Carry Generate Output (Active LOW)	50/33.3	-1 mA/20 mA
$\bar{P}$	Carry Propagate Output (Active LOW)	50/33.3	-1 mA/20 mA
F_0-F_3	Function Outputs	50/33.3	-1 mA/20 mA

Functional Description

Signals applied to the Select inputs S_0-S_2 determine the mode of operation, as indicated in the Function Select Table. An extensive listing of input and output levels is shown in the Truth Table. The circuit performs the arithmetic functions for either active HIGH or active LOW operands, with output levels in the same convention. In the Subtract operating modes, it is necessary to force a carry (HIGH for active HIGH operands, LOW for active LOW operands) into the C_n input of the least significant package.

The Carry Generate ($\bar{G}$) and Carry Propagate ($\bar{P}$) outputs supply input signals to the 74F182 carry lookahead generator for expansion to longer word length, as shown in Figure 2. Note that an 74F382 ALU is used for the most significant package. Typical delays for Figure 2 are given in Figure 1.

Function Select Table

Select			Operation
S_0	S_1	S_2	
L	L	L	Clear
H	L	L	B Minus A
L	H	L	A Minus B
H	H	L	A Plus B
L	L	H	$A \oplus B$
H	L	H	$A + B$
L	H	H	AB
H	H	H	Preset

H = HIGH Voltage Level
L = LOW Voltage Level

Path Segment	Toward F	Output $C_n + 4, OVR$
A_i or B_i to $\bar{P}$	7.2 ns	7.2 ns
$\bar{P}_i$ to $C_n + 1$ (F182)	6.2 ns	6.2 ns
C_n to F	8.1 ns	—
C_n or $C_n + 4, OVR$	—	8.0 ns
Total Delay	21.5 ns	21.4 ns

FIGURE 1. 16-Bit Delay Tabulation

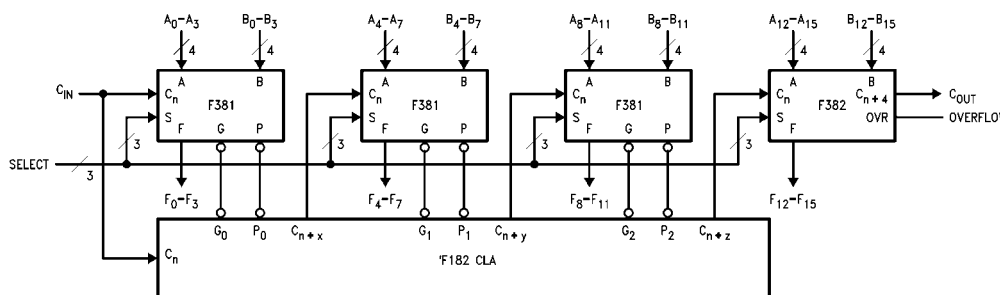


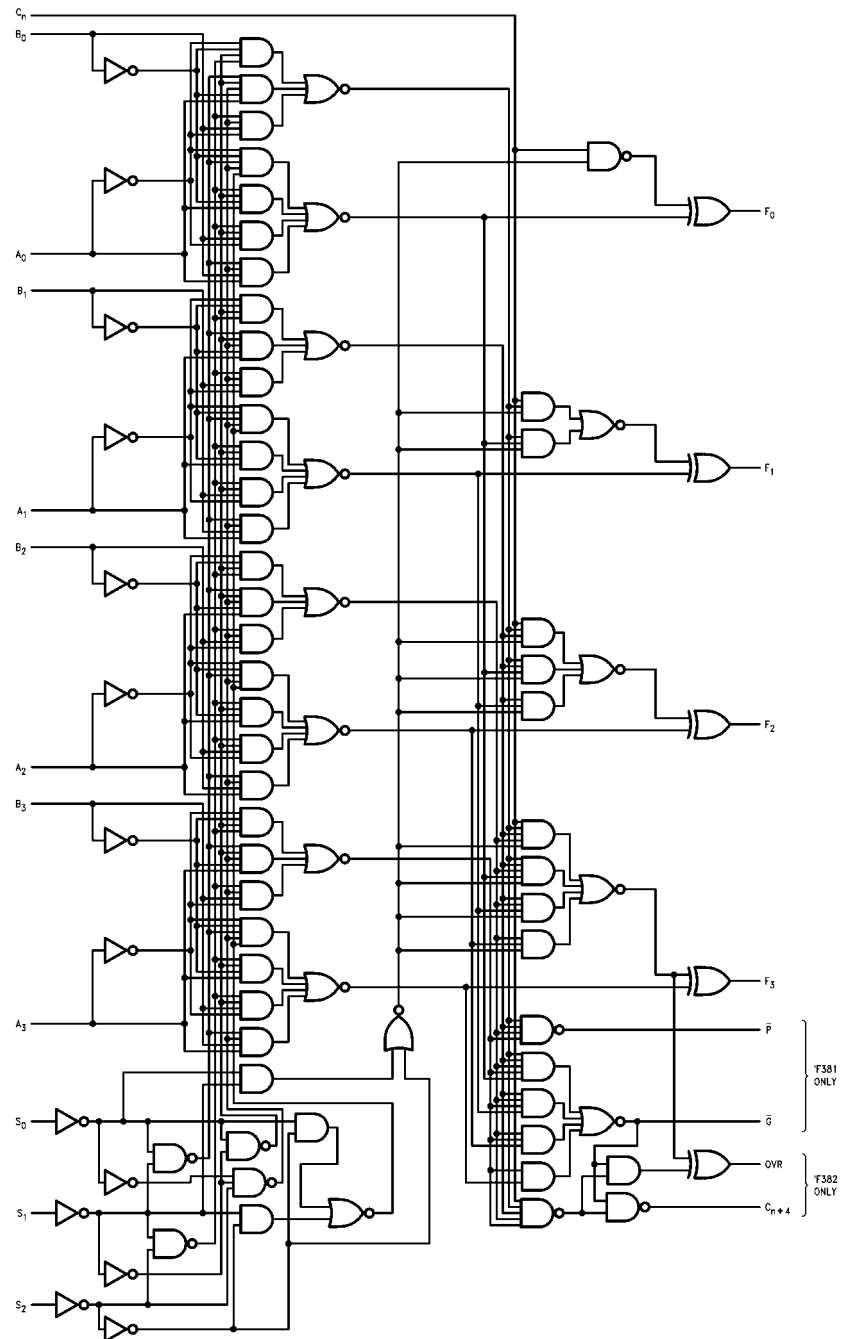
FIGURE 2. 16-Bit Lookahead Carry ALU Expansion

Truth Table

	Inputs						Outputs					
Function	S ₀	S ₁	S ₂	C _n	A _n	B _n	F ₀	F ₁	F ₂	F ₃	$\overline{G}$	$\overline{P}$
CLEAR	L	L	L	X	X	X	L	L	L	L	L	L
B Minus A	H	L	L	L	L	L	H	H	H	H	H	L
				L	L	H	L	H	H	H	L	L
				L	H	L	L	L	L	L	H	H
				L	H	H	H	H	H	H	H	L
				H	L	L	L	L	L	L	H	L
				H	L	H	H	H	H	H	L	L
				H	H	L	H	L	L	L	H	H
				H	H	H	L	L	L	L	H	L
A Minus B	L	H	L	L	L	L	H	H	H	H	H	L
				L	L	H	L	L	L	L	H	H
				L	H	L	L	H	H	H	L	L
				L	H	H	H	H	H	H	H	L
				H	L	L	L	L	L	L	H	L
				H	L	H	H	L	L	L	H	H
				H	H	L	L	H	H	H	L	L
				H	H	H	L	L	L	L	H	L
A Plus B	H	H	L	L	L	L	L	L	L	L	H	H
				L	L	H	H	H	H	H	H	L
				L	H	L	H	H	H	H	L	L
				L	H	H	L	H	H	H	H	H
				H	L	L	L	L	L	L	H	L
				H	L	H	L	L	L	L	H	L
				H	H	L	L	L	L	L	H	L
				H	H	H	H	H	H	H	L	L
A ⊕ B	L	L	H	X	L	L	L	L	L	L	H	H
				X	L	H	H	H	H	H	H	H
				X	H	L	L	H	H	H	H	L
				X	H	H	L	L	L	L	L	L
A + B	H	L	H	X	L	L	L	L	L	L	H	H
				X	L	H	H	H	H	H	H	H
				X	H	L	L	H	H	H	H	H
				X	H	H	H	H	H	H	H	L
AB	L	H	H	X	L	L	L	L	L	L	L	L
				X	L	H	L	L	L	L	L	L
				X	H	L	L	L	L	L	L	L
				X	H	H	H	H	H	H	H	L
PRESET	H	H	H	X	L	L	H	H	H	H	H	H
				X	L	H	H	H	H	H	H	H
				X	H	L	L	H	H	H	H	H
				X	H	H	H	H	H	H	H	L

H = HIGH Voltage Level
L = LOW Voltage Level
X = Immaterial

Logic Diagram



Please note that this diagram is provided only for the understanding of logic operations and should not be used to estimate propagation delays.

Absolute Maximum Ratings(Note 1)

Storage Temperature	–65°C to +150°C
Ambient Temperature under Bias	–55°C to +125°C
Junction Temperature under Bias	–55°C to +150°C
V _{CC} Pin Potential to Ground Pin	–0.5V to +7.0V
Input Voltage (Note 2)	–0.5V to +7.0V
Input Current (Note 2)	–30 mA to +5.0 mA

Voltage Applied to Output

in HIGH State (with V_{CC} = 0V)Standard Output –0.5V to V_{CC}

3-STATE Output –0.5V to +5.5V

Current Applied to Output

in LOW State (Max) twice the rated I_{OL} (mA)**Recommended Operating Conditions**

Free Air Ambient Temperature	0°C to +70°C
Supply Voltage	+4.5V to +5.5V

Note 1: Absolute maximum ratings are values beyond which the device may be damaged or have its useful life impaired. Functional operation under these conditions is not implied.

Note 2: Either voltage limit or current limit is sufficient to protect inputs.

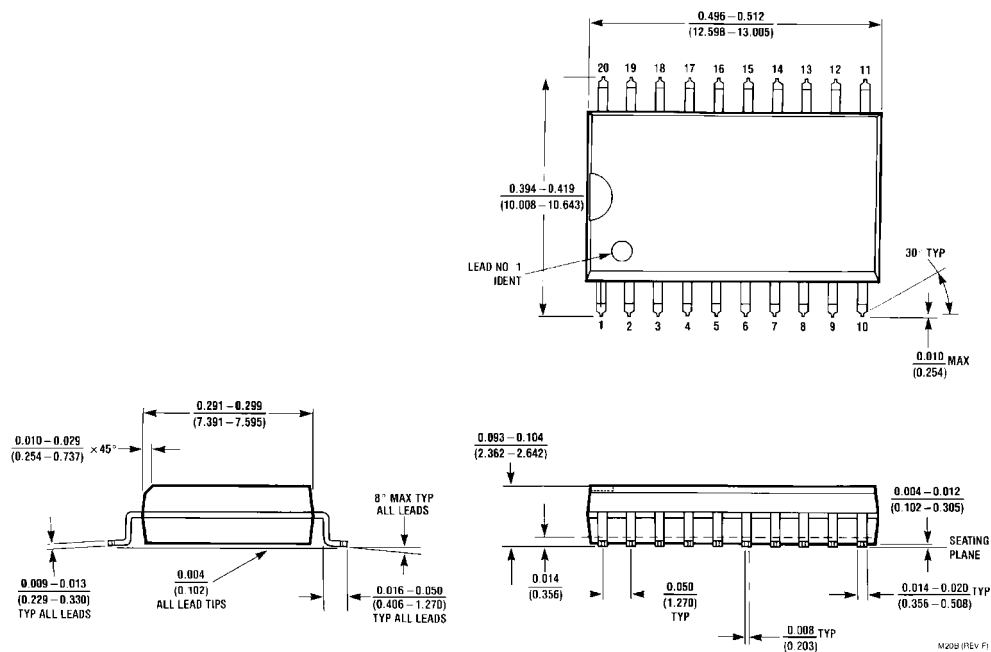
DC Electrical Characteristics

Symbol	Parameter	Min	Typ	Max	Units	V _{CC}	Conditions
V _{IH}	Input HIGH Voltage	2.0			V		Recognized as a HIGH Signal
V _{IL}	Input LOW Voltage			0.8	V		Recognized as a LOW Signal
V _{CD}	Input Clamp Diode Voltage			–1.2	V	Min	I _{IN} = –18 mA
V _{OH}	Output HIGH Voltage	10% V _{CC} 5% V _{CC}	2.5 2.7		V	Min	I _{OH} = –1 mA I _{OH} = –1 mA
V _{OL}	Output LOW Voltage	10% V _{CC}		0.5	V	Min	I _{OL} = 20 mA
I _{IH}	Input HIGH Current			5.0	μA		V _{IN} = 2.7V
I _{BVI}	Input HIGH Current Breakdown Test			7.0	μA	Max	V _{IN} = 7.0V
I _{CEX}	Output HIGH Leakage Current			50	μA	Max	V _{OUT} = V _{CC}
V _{ID}	Input Leakage Test	4.75			V	0.0	I _{ID} = 1.9 μA All Other Pins Grounded
I _{OD}	Output Leakage Circuit Current			3.75	μA	0.0	V _{IOD} = 150 mV All Other Pins Grounded
I _{IL}	Input LOW Current			–0.6 –1.8 –2.4	mA mA mA	Max Max Max	V _{IN} = 0.5V (S _n) V _{IN} = 0.5V (A _n , B _n) V _{IN} = 0.5V (C _n)
I _{OS}	Output Short-Circuit Current	–60		–150	mA	Max	V _{OUT} = 0V
I _{CC}	Power Supply Current		59	89	mA	Max	

AC Electrical Characteristics

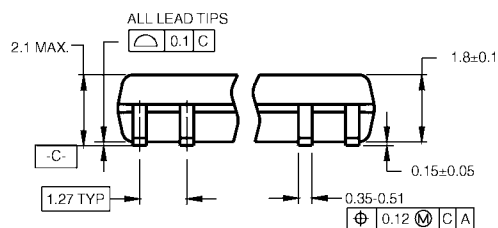
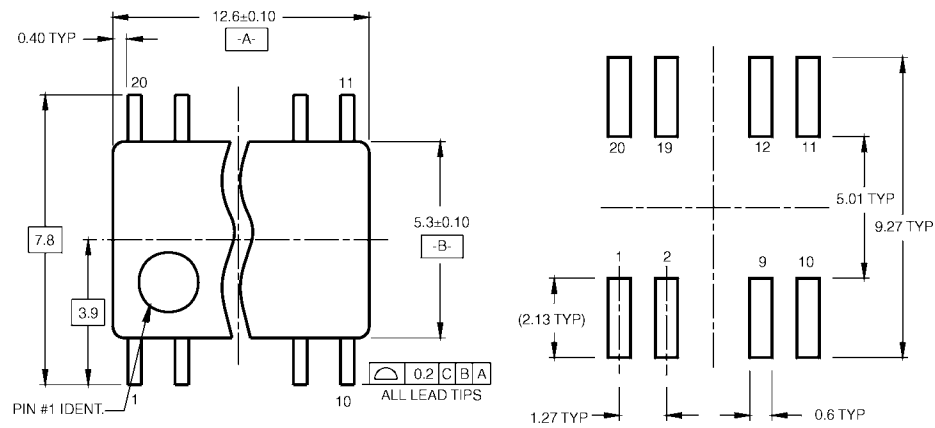
Symbol	Parameter	T _A = +25°C V _{CC} = +5.0V C _L = 50 pF			T _A = 0°C to +70°C V _{CC} = +5.0V C _L = 50 pF		Units
		Min	Typ	Max	Min	Max	
t _{PLH}	Propagation Delay	2.5	8.1	12.0	2.5	13.0	ns
t _{PHL}	C _n to F _i	2.5	5.7	8.0	2.5	9.0	
t _{PLH}	Propagation Delay	4.0	10.4	15.0	4.0	16.0	ns
t _{PHL}	Any A or B to Any F	3.5	8.2	11.0	3.5	12.0	
t _{PLH}	Propagation Delay	4.5	8.3	20.5	4.5	21.5	ns
t _{PHL}	S _i to F _i	4.0	8.2	15.0	4.0	16.0	
t _{PLH}	Propagation Delay	3.5	6.4	10.0	3.5	11.0	ns
t _{PHL}	A _i or B _i to $\overline{G}$	3.5	6.8	10.0	3.0	11.0	
t _{PLH}	Propagation Delay	2.5	7.2	10.5	2.5	11.5	ns
t _{PHL}	A _i or B _i to $\overline{P}$	3.5	6.5	9.5	3.5	10.5	
t _{PLH}	Propagation Delay	4.0	7.8	12.0	4.0	13.0	ns
t _{PHL}	S _i to $\overline{G}$ or $\overline{P}$	4.5	10.2	13.5	4.5	14.5	

Physical Dimensions inches (millimeters) unless otherwise noted



20-Lead Small Outline Integrated Circuit (SOIC), JEDEC MS-013, 0.300 Wide
Package Number M20B

Physical Dimensions inches (millimeters) unless otherwise noted (Continued)

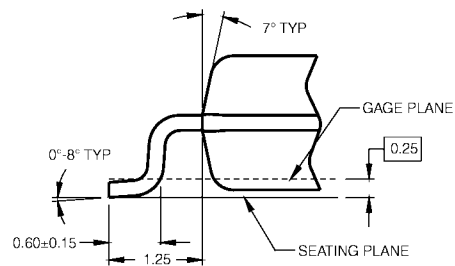


DIMENSIONS ARE IN MILLIMETERS

NOTES:

- CONFORMS TO EIAJ EDR-7320 REGISTRATION, ESTABLISHED IN DECEMBER, 1998.
- DIMENSIONS ARE IN MILLIMETERS.
- DIMENSIONS ARE EXCLUSIVE OF BURRS, MOLD FLASH, AND TIE BAR EXTRUSIONS.

M20DRevB1



DETAIL A

**20-Lead Small Outline Package (SOP), EIAJ TYPE II, 5.3mm Wide
Package Number M20D**

